

# DATA SHEET

Part No.	AN26130A
Package Code No.	XLGA012-L-0303

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# AN26130A

Loop through Amplifier IC for VHF & UHF Band (40 MHz to 900 MHz) Applications

## ■ Overview

- AN26130A is a Loop through amplifier IC for VHF and UHF band (40 MHz to 900 MHz) applications.
- Realizing high performance by using 0.30  $\mu\text{m}$  Bi-CMOS process ( $f_T = 20 \text{ GHz}$ ,  $f_{\text{max}} = 20 \text{ GHz}$ ).
- Off and Loop through mode is Changeable, Controlled by Integrated CMOS logic circuit.
- Achieving miniaturization by using small size package.

## ■ Features

- 1-IN, 2-OUT Active Loop through.
- Operation voltage +3.30 V typ.
- Current consumption 120 mA typ. (Loop through mode)  
0.1  $\mu\text{A}$  typ. (Off through mode)
- Gain
 

RF_OUT1	10.0 dB typ.	$f_{\text{RX}} = 620 \text{ MHz}$ , $Z_0 = 50 \Omega$
RF_OUT2	-4.0 dB typ.	$f_{\text{RX}} = 620 \text{ MHz}$ , $Z_0 = 50 \Omega$
- Low noise figure RF\_OUT1 4.0 dB typ.  $f_{\text{RX}} = 620 \text{ MHz}$ ,  $Z_0 = 50 \Omega$
- Low distortion RF\_OUT1 14.0 dBm typ.  $f_{\text{RX}} = 620 \text{ MHz}$ ,  $Z_0 = 50 \Omega$
- Small package (12 pin Plastic Package).

## ■ Applications

- VHF & UHF band (40 MHz to 900 MHz) applications

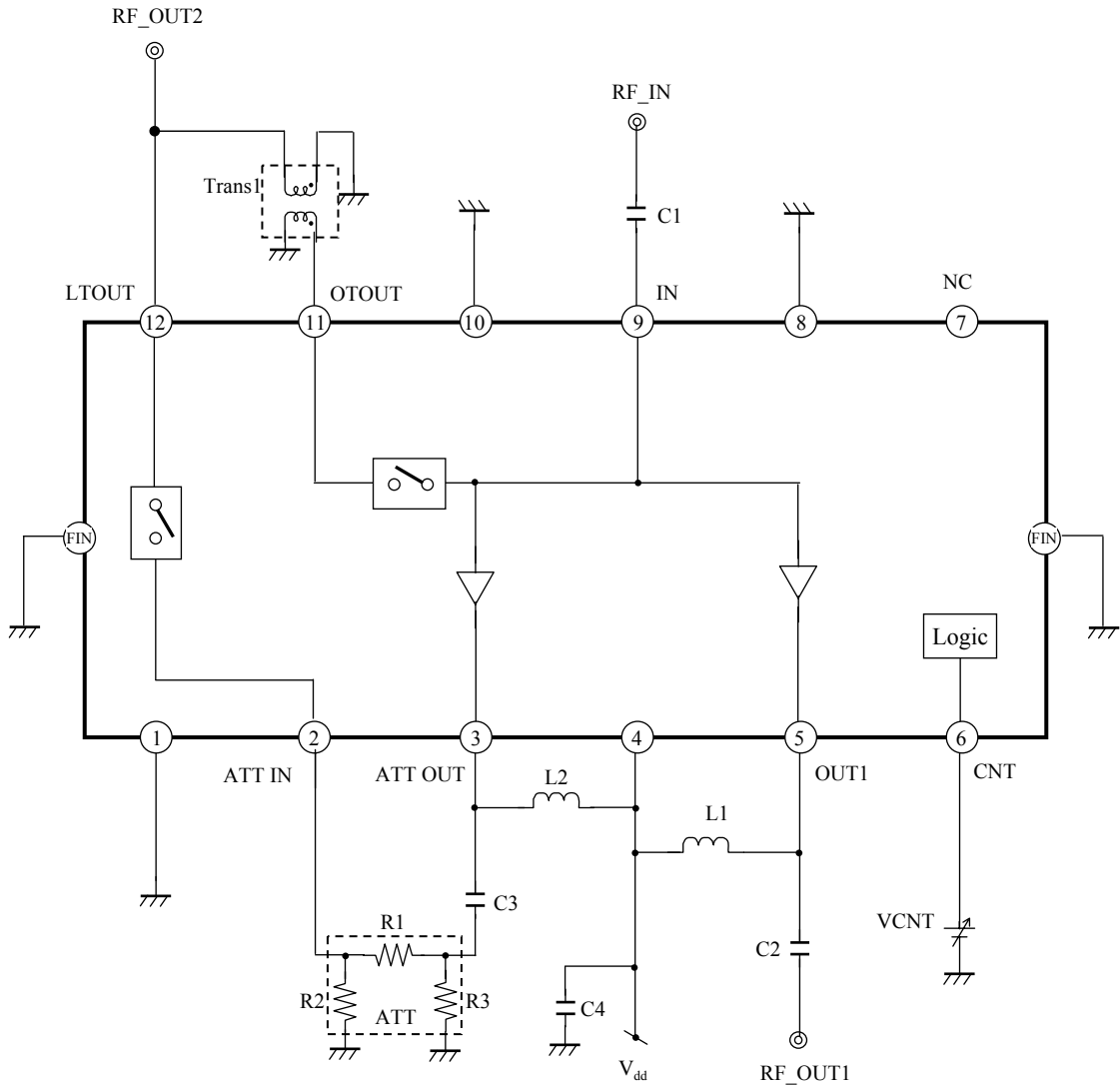
## ■ Package

- 12 pin Fine Pitch Land Grid Array Package (LGA Type)  
Size : 3.00 mm  $\times$  2.50 mm  $\times$  0.80 mm

## ■ Type

- Bi-CMOS IC

■ Application Circuit Example (Block Diagram)



- Notes)
- This application circuit is an example. The operation of mass production set is not guaranteed. Perform enough evaluation and verification on the design of mass production set.
  - This block diagram is for explaining functions. The part of the block diagram may be omitted, or it may be simplified.

## ■ Pin Descriptions

Pin No.	Pin name	Type	Description
1	V <sub>SS1</sub>	Ground	V <sub>SS</sub>
2	ATT IN	Input	ATT input
3	ATT OUT	Output	ATT output
4	V <sub>DD</sub>	Power supply	V <sub>DD</sub>
5	OUT1	Output	RF output 1
6	CNT	Input	Off and Loop through mode control input
7	NC	NC	Non connect
8	V <sub>SS2</sub>	Ground	V <sub>SS</sub>
9	IN	Input	RF input
10	V <sub>SS3</sub>	Ground	V <sub>SS</sub>
11	OT OUT	Output	Off through output
12	LT OUT	Output	Loop through output
FIN	V <sub>SS4</sub>	Ground	V <sub>SS</sub>

### ■ Absolute Maximum Ratings

Note) Absolute maximum ratings are limit values which do not result in damages to this IC, and IC operation is not guaranteed at these limit values.

A No.	Parameter	Symbol	Rating	Unit	Notes
1	Supply voltage	$V_{DD}$	3.6	V	*1
2	Supply current	$I_{DD}$	170	mA	—
3	Power dissipation	$P_D$	65.5	mW	*2
4	Operating ambient temperature	$T_{opr}$	-20 to +80	°C	*3
5	Storage temperature	$T_{stg}$	-40 to +150	°C	*3

Notes) \*1 : The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

\*2 : The power dissipation shown is the value at  $T_a = 80^\circ\text{C}$  for the independent (unmounted) IC package without a heat sink.

When using this IC, refer to  $\bullet P_D$ - $T_a$  diagram in the ■ Technical Data standard and design the heat radiation with sufficient margin so that the allowable value might not be exceeded based on the conditions of power supply voltage, load, and ambient temperature.

\*3 : Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for  $T_a = 25^\circ\text{C}$ .

### ■ Operating Supply Voltage Range

Parameter	Symbol	Range	Unit	Notes
Supply voltage range	$V_{DD}$	3.13 to 3.47	V	*1

Note) \*1 : The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

### ■ Allowable Voltage Range

- Notes) • Allowable current and voltage ranges are limit ranges which do not result in damages to this IC, and IC operation is not guaranteed within these limit ranges.  
 • Do not apply voltage to N.C. pins.  
 • Voltage values are with respect to the GND.  
 • Applying external voltage to any pin not mentioned below leads to the malfunction and the damage of the device.  
 • Below ratings are specified for prevention of malfunction and stress, not for guaranteed operation.

Pin No.	Pin name	Rating	Unit	Notes
12	LT OUT	$-0.3$ to $(V_{DD} + 0.3)$	V	*2
11	OT OUT	$-0.3$ to $(V_{DD} + 0.3)$	V	*2
9	IN	—	V	*1
6	CNT	$-0.3$ to $(V_{DD} + 0.3)$	V	—
5	OUT1	$(V_{DD} - 0.05)$ to $(V_{DD} + 0.05)$	V	*3
3	ATT OUT	$(V_{DD} - 0.05)$ to $(V_{DD} + 0.05)$	V	*3
2	ATT IN	—	V	*1

Notes) \*1 : RF signal input pin (Maximum input power is +17dBm). Do not apply DC current.

\*2 : RF signal output pin. Do not apply DC current.

\*3 : RF signal output pin with DC current. Do not apply a voltage different from  $V_{DD}$  voltage.

### ■ Electrical Characteristics at $V_{DD} = 3.30\text{ V}$

Note)  $T_a = 25^\circ\text{C} \pm 2^\circ\text{C}$  unless otherwise specified.

B No.	Parameter	Symbol	Conditions	Limits			Unit	Notes
				Min	Typ	Max		
DC Electrical Characteristics								
DC-1	Supply current LT	$I_{DDLT}$	$V_{DD}$ current at Loop through mode No input signal	—	120	160	mA	—
DC-2	Supply current OT	$I_{DDOT}$	$V_{DD}$ current at Off through mode No input signal	—	0.1	10	$\mu\text{A}$	—
DC-3	SW voltage (Loop through mode)	$V_{IH}$	$V_{IH} = V_{DD} \times 0.85$	2.805	3.30	—	V	—
DC-4	SW voltage (Off through mode)	$V_{IL}$	$V_{IL} = V_{DD} \times 0.10$	—	0.0	0.33	V	—
DC-5	SW current (High)	$I_{IH}$	Current at CNT pin $V_{IH} = V_{DD}$	—	3.3	10	$\mu\text{A}$	—



■ Electrical Characteristics (continued) at  $V_{DD} = 3.30\text{ V}$

Note)  $T_a = 25^\circ\text{C} \pm 2^\circ\text{C}$ ,  $f_{RX} = 620\text{ MHz}$ ,  $PRX = -15\text{ dBm}$ ,  $Z_0 = 50\ \Omega$ , CW unless otherwise specified.

B No.	Parameter	Symbol	Conditions	Limits			Unit	Notes
				Min	Typ	Max		
AC Electrical Characteristics								
A-1	Power Gain OUT1	G1S	Loop through mode $f = f_{RX}$	7.5	10	12.5	dB	—
A-2	Loop through Gain OUT2	GLTS	Loop through mode $f = f_{RX}$	-7.0	-4.0	-1.0	dB	—
A-3	Off through Gain OUT2	GOTS	Off through mode $f = f_{RX}$	-6.0	-4.0	-2.0	dB	—
A-4	IIP3 + 10 MHz offset OUT1 Loop through	IIP311S	Loop through mode OUT1 $f1 = f_{RX}$ $f2 = f_{RX} + 10\text{ MHz}$ Input 2 signals ( $f1, f2$ )	8.0	14.0	—	dBm	—

### ■ Control Pin Mode Table

Note) Control voltage range : See B No. DC-3 / B No. DC-4 at page 8

Pin No.	Description	Pin voltage		Remarks
		Low	High	
6	Loop through/Off through Switching (Mode Control)	Off through	Loop through	—

### ■ Truth Table

Note) Control voltage range : See B No. DC-3 / B No. DC-4 at page 8

CNT	IC	Mode
High	Loop through	Loop through
Low	Off through	Off through

■ Technical Data

- I/O block circuit diagrams and pin function descriptions

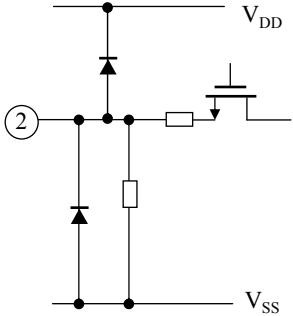
Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

Pin No.1	Voltage	Internal Circuit	Descriptions
11,12	—		OTOUT (Loop through output), LTOUT (Off through output)
9	1.4 V		IN (RF input)
1,8,10,12	0.0 V	—	V <sub>SS</sub> (Ground)
6	—		CNT (Loop through/Off through mode control input)
3,5	—		OUT1 (RF output 1), ATT OUT (ATT output)
4	3.30 V		V <sub>DD</sub> (Power supply)

■ Technical Data (continued)

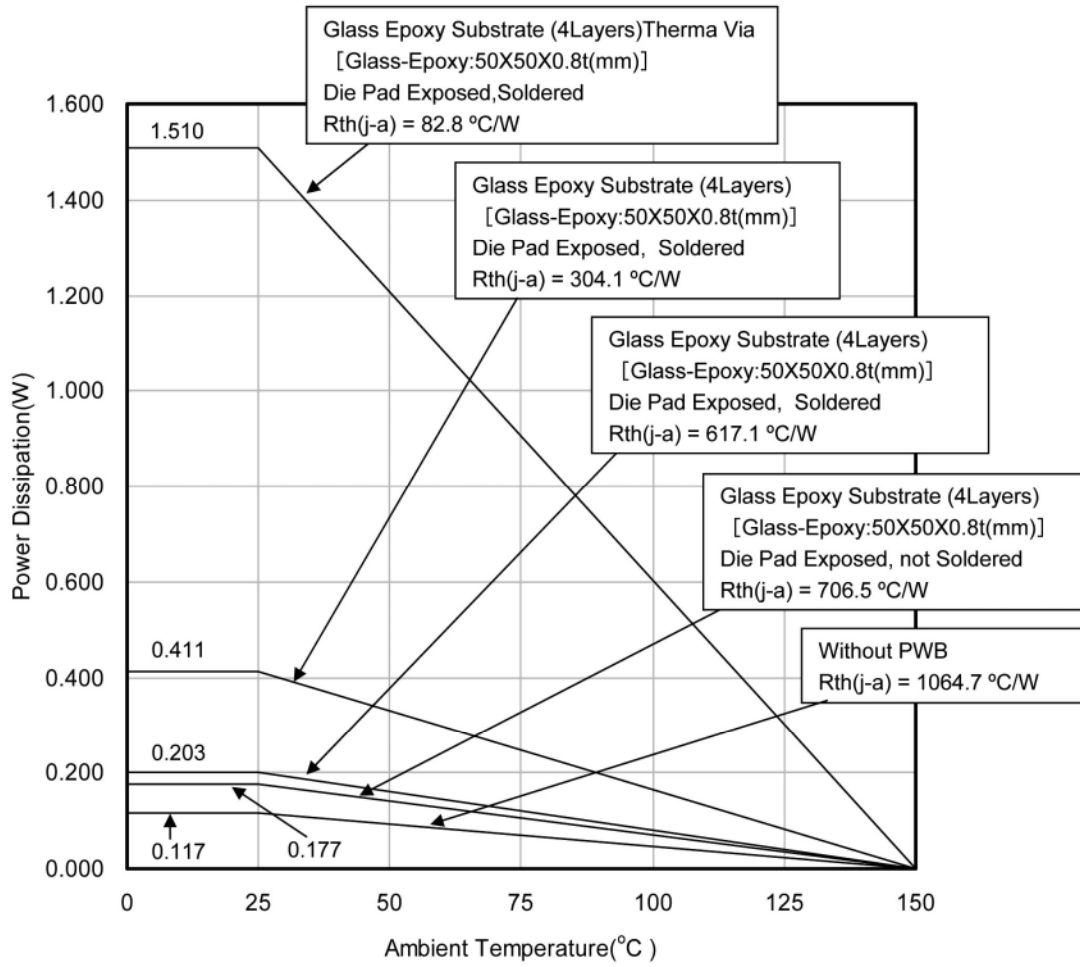
- I/O block circuit diagrams and pin function descriptions (Continued)

Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

Pin No.	Voltage	Internal Circuit	Descriptions
2	—		ATT IN (ATT input)

■ Technical Data (continued)

- $P_D - T_a$  diagram



**■ Usage Notes****• Special attention and precaution in using**

1. This IC is intended to be used for general electronic equipment [TV].

Consult our sales staff in advance for information on the following applications:

- Special applications in which exceptional quality and reliability are required, or if the failure or malfunction of this IC may directly jeopardize life or harm the human body.
- Any applications other than the standard applications intended.
  - (1) Space appliance (such as artificial satellite, and rocket)
  - (2) Traffic control equipment (such as for automobile, airplane, train, and ship)
  - (3) Medical equipment for life support
  - (4) Submarine transponder
  - (5) Control equipment for power plant
  - (6) Disaster prevention and security device
  - (7) Weapon
  - (8) Others : Applications of which reliability equivalent to (1) to (7) is required

It is to be understood that our company shall not be held responsible for any damage incurred as a result of or in connection with your using the IC described in this book for any special application, unless our company agrees to your using the IC in this book for any special application.

2. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuit-board), it might smoke or ignite.
3. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
4. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solder-bridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
5. Take notice in the use of this product that it might break or occasionally smoke when an abnormal state occurs such as output pin- $V_{CC}$  short (Power supply fault), output pin-GND short (Ground fault), or output-to-output-pin short (load short) .  
And, safety measures such as an installation of fuses are recommended because the extent of the above-mentioned damage and smoke emission will depend on the current capability of the power supply.
6. When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.  
Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
7. When using the LSI for new models, verify the safety including the long-term reliability for each product.
8. When the application system is designed by using this LSI, be sure to confirm notes in this book.  
Be sure to read the notes to descriptions and the usage notes in the book.

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